

General Description

The WSR80N10D use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switchingand excellent avalanche characteristics.

This device is specially designed to get better ruggedness and suitable to use in.

Features

Low RDS(on) & FOM Extremely low switching loss Excellent stability and uniformity or Invertors

Product Summery

BVDSS	RDSON	ID
100V	$9 \text{m}\Omega$	60A

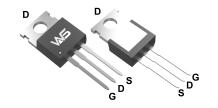
Applications

Consumer electronic power supply Motor control

Synchronous-rectification Isolated DC

Synchronous-rectification applications

TO-220AB Pin Configuration





Absolute Maximum Ratings at T_j=25°C unless otherwise noted

Symbol	Parameter		Value	Unit	
VDS	Drain source voltage		100	V	
Vgs	Gate source voltage	±20	V		
ΙD	Continuous drain current ₁)	60	Α		
ID, pulse	Pulsed drain current ₂₎ TC=25 °C		180	А	
PD	Power dissipation ₃₎ TC=25 °C		107	W	
Eas	Single pulsed avalanche energy ₄₎		183.8	mJ	
T _{stg} , T _j	Operation and storage temperature		-55 to 150	°C	
Rejc	Thermal resistance, junction-case		1.17	°C/W	
RөJA	Thermal resistance, junction-ambient ₄₎	62	°C/W		



Electrical Characteristics at T_j=25 °C unless otherwise specified

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
BVDSS	Drain-source breakdown voltage	V _G s=0 V, I _D =250 μA	100	-	-	V
V _{GS(th)}	Gate threshold voltage	V _{DS} =V _{GS} , I _D =250 μA	1.5	-	2.5	V
RDS(ON)	Drain-source on-state resistance	Vgs=10 V, Ip=20 A	-	9	10.0	mΩ
RDS(ON)	Drain-source on-state resistance	Vgs=4.5 V, Ip=12 A	-	12	14.0	mΩ
lgss	Gate-source leakage current	V _{GS} =20 V	-	-	100	nA
		V _{GS} =-20 V	-	-	-100	
IDSS	Drain-source leakage current	V _{DS} =100 V, V _{GS} =0 V	-	-	1	uA
Rg	Gate resistance	f= 1 MHz, Open drain	-	5.5	-	Ω
Ciss	Input capacitance		-	1999	-	pF
Coss	Output capacitance	V _{GS} =0 V, V _{DS} =50 V, f=100 kHz	-	322	-	pF
Crss	Reverse transfer capacitance	V _{GS} =10 V,	-	7.1	-	pF
t d(on)	Turn-on delay time		-	22.1	-	ns
tr	Rise time	V _{DS} =50 V,	-	5.2	-	ns
t d(off)	Turn-off delay time	R _G =2 Ω,	-	44	-	ns
tf	Fall time		-	8.4	-	ns
Qg	Total gate charge		-	28.9	-	nC
Qgs	Gate-source charge	In=25 A In=25 A,	-	6	-	nC
Qgd	Gate-drain charge	V _{DS} =50 V,	-	6.8	-	nC
V _{plateau}	Gate plateau voltage	V _{GS} =10 V V _{GS} <v<sub>th</v<sub>	-	3.7	-	V
ls	Diode forward current		-	-	60	Α
Isp	Pulsed source current		-	-	180	Α
VsD	Diode forward voltage	Is=20 A, Vgs=0 V	-	-	1.3	٧
trr	Reverse recovery time	Is=25 A, di/dt=100 A/μs	-	102.9	-	ns
Qrr	Reverse recovery charge		-	379	-	nC
Irrm	Peak reverse recovery current		-	6.4	-	Α

Note

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) Pd is based on max. junction temperature, using junction-case thermal resistance.
- 4) V_{DD}=50 V, R_G=25 Ω , L=0.3 mH, starting T_j=25 °C.
- 5) The value of Reja is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper,

in a still air environment with Ta=25 °C.



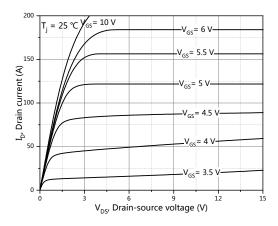


Figure 1, Typ. output characteristics

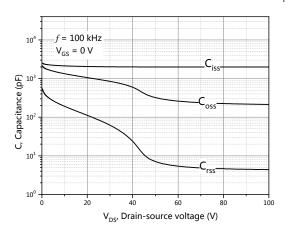


Figure 3, Typ. capacitances

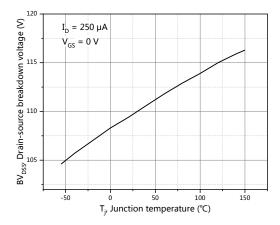


Figure 5, Drain-source breakdown voltage

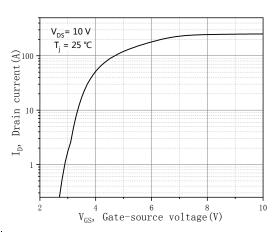


Figure 2, Typ. transfer characteristics

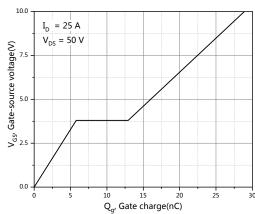


Figure 4, Typ. gate charge

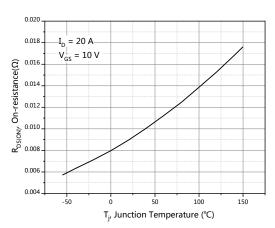
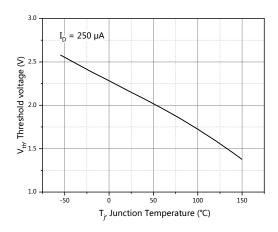
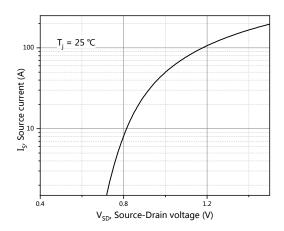


Figure 6, Drain-source on-state resistance







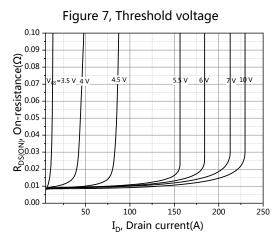


Figure 8, Forward characteristic of body diode

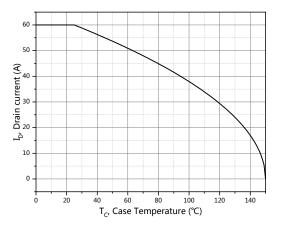


Figure 9, Drain-source on-state resistance

Figure 10, Drain current

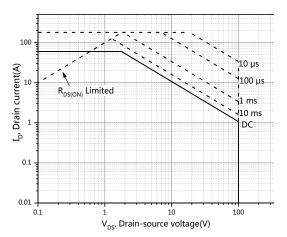


Figure 11, Safe operation area T_C=25 ℃



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